SHARP GP2W1001YP

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■ Features

- 1. Integrated package of light emitter and receiver. (10.0×4.4×H3.5 mm)
- 2. Low profile type (Height: 3.5 mm)
- 3. Compliant with IrDA1.0 and IrDA1.1
- 4. Low voltage operation type (Supply voltage:2.4V to 5.5V)
- 5. Low dissipation current thanks to power down mode (Dissipation current at shut-doen mode:Max. $1\mu A$)
- 6. Applicable for reflow soldering
- 7. With shield case

■ Applications

1. Personal computers

Storage temperature

2. Personal information tools

■ Absolute Maximum Ratings (Ta=2							
Parameter	Symbol	Rating	Unit				
Supply voltage	Vcc	6	V				
Transmission signal duty ratio	TXduty	50	%				
Operating temperature	Topr	-10 to +70	°C				

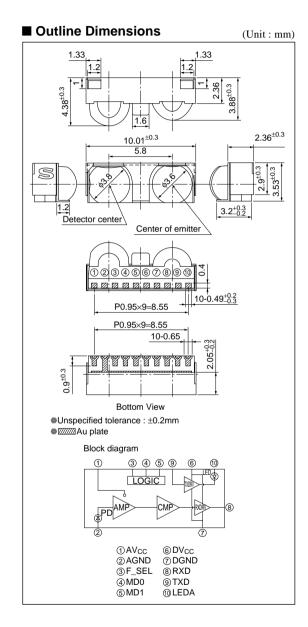
Note) Transmission signal duty ratio show the time share of H level of transmission wave at TX terminal. The frequency shall be 1kHz or more.

Tstg

°C

-20 to +85

Low Profile Type IrDA Transceiver Module Compliant with IrDA1.1



ı	Recommended Operating Conditions $(Ta=25^{\circ}C)$							
	Parameter	Symbol	Rating	Unit				
	Operating Supply voltage	Vcc	2.7 to 5.5	V				
Operating temperature		Topr	0 to +70	°C				
	SIR bit rate	_	9.6 to 115.2	kbps				
	FIR bit rate	_	1.152/4	Mbps				

■ Electro-optical Characteristics (Ta=25±3°C, Vcc=3.3±0.1V, 5±0.1V, Ambient illuminance of detecting face: 100lx or less)

	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	Dissipation current at no input signal		Icc	RXOUT:H, TXIN:L, Vcc=3.3V	-	-	1.2	mA
			Icc	RXOUT:H, TXIN:L, Vcc=5.0V –		_	1.5	mA
	S/D dissipation current		Iccs	RXOUT:H, TXIN:L, Vcc=3.3V		0.1	1	μΑ
			Iccs	RXOUT:H, TXIN:L, Vcc=5.0V	_	0.2	2	μΑ
	Dissipation current		Iccp	Peak Value, Vcc=3.3V (2.4Ω), 5.0V (6.8Ω)	_	400	600	mA
	Switching time (Shut down to stand by)		trsd		-	-	1.5	ms
	Receiver sensitivi		Srxθ	SIR:9.6k to 115.2kbps	0.04	=	5 000	W/m ²
	(-15	°≤ 0 ≤+15°)	Srxθ	FIR:1.152M/4Mbps	0.01	-	5 000	W/m ²
ide	Low level output	voltage	Vol	Vcc=3.3, 5.0V	-	-	0.4	V
er si	High level output	voltage	Voh	Vcc=3.3, 5.0V	Vcc-0.4	_	-	V
Receiver side	Rise time		trrA	SIR:9.6k to 115.2kbps	_	_	200	ns
Rec	Kise tille		trrB	FIR:1.152M/4Mbps	-	-	40	ns
	Fall time		tfrA	SIR:9.6k to 115.2kbps	_	_	200	ns
			t frB	FIR:1.152M/4Mbps	-	=	40	ns
	Peak sensitivity wavelength		$\lambda_{\rm rx}$		-	940	_	nm
	Low level pules width tw tw		tw1	SIR:Pulse width 19.53µs(9.6kbps), Duty 3/16	1	_	22	μs
			tw2	SIR:Pulse width 1.63µs(115.2kHz), Duty 3/16	1	-	3	μs
			tw3	FIR:Pulse width 217ns(1.152Mbps), Duty 1/4	110	-	500	ns
			tw4	FIR:Pules width Single 125ns(4Mbps), Duty 1/4	85	_	165	ns
			tw5	FIR:Pules width Double 250ns(4Mbps), Duty 1/4	210	-	290	ns
	Peak emission wavelength		$\lambda_{\rm tx}$		850	880	900	nm
	Radiant intensity	ф=0°	Ielo	Low Power	-	15	_	mW/sr
e		ф=0°	Іемо	Middle Power	-	60	_	mW/sr
side		−15°≤φ≤+15°	Iefθ	Full Power	100	_	500	mW/sr
itter	Low level input voltage		$V_{\rm IL}$	Vcc=3.3, 5.0V	-	_	Vcc×0.2	V
Transmitter	High level input voltage		V _{IH}	Vcc=3.3, 5.0V	Vcc×0.2	_	_	V
ran	TXin terminal input current		Iн	TXIN=Vcc=5.0V	_	_	50	μΑ
			IIL	TXIN=GND	-0.1	0	0.1	μΑ
	Transmission sign		t rtx		_	_	40	ns
	Transmission sign	al fall time	t ftx		_	_	40	ns

■ Truth Table

Inj	put	Output		
TXD (Transmitter)	*1 Receiver	State of LED (Transmitter)	RXD terminal	
High	_	ON	X	
Low	ON	OFF	Low	
Low	OFF	OFF	High	

X:Do not care

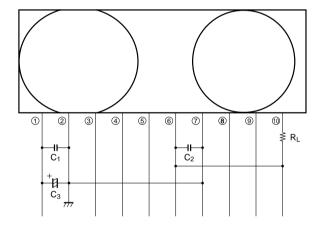
^{*1} External optical signal receiving state of photodiode

■ Input Output Logic Table

MD0	MD1	F_SEL	TXD	RXD terminal mode	TXO *2	Remarks
1	0	X	0	Shut down	Shut down	_
	0	1	0	RXA	X	Latch TXD *1
	0	1	1	RXB	X	Latch TXD *1
0	0	0	X	RXA	HPW	TXO Output High Power mode
0	1	0	X	↓ ↓	MPW	TXO Output Middle Power mode
1	1	0	X	↓ ↓	LPW	TXO Output Low Power mode
0	0	1	X	RXB	HPW	TXO Output High Power mode
0	1	1	X		MPW	TXO Output Middle Power mode
1	1	1	X	↓ ↓	LPW	TXO Output Low Power mode

^{*1} F_SFL \rightarrow 0:reset latching state of TXD, and turn to RXA channel. RXA:RXA channel mode:115kbps or less (SIR 115.2kbps, 9 600bps) RXB:RXB channel mode:115kbps or more (FIR 1.152Mbps, 4Mbps)

Fig.1 Recommended External Circuit

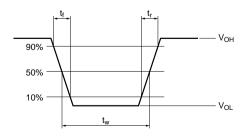


- 2 AGND
- ③ F_SEL
- ④ MD0 ⑤ MD1
- ⑥ DV_{CC}⑦ DGND
- ® RXD
- ① LEDA

	Components	Recommended values
	C ₁ •C ₂	1μF±10% (Note 1)
	C ₃	4.7μF±10% (Note 2)
_	R_{L}	2.4Ω±5% 1/2W
		(V _{CC} =3.3V)
		6.8Ω±5% 1/2W
		(V _{CC} =5V)

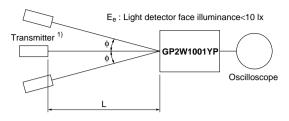
- (Note 1) Please locate nearby this transceiver choosing the ceramic capacitor with higher frequency feature
- (Note 2) Please choose the most suitable C_X according to the noise level and noise frequency of power supply

Fig.2 Output Waveform Specification(Receiver side)(C∟≤10pF)



^{*2} LED operating mode

Fig.3 Standard Optical System(Receiver side)



φ: Indicates horizontal and vertical directions.

The light emitting diode (SHARP **GL710**, λp =850 to 900nm) is used as the transmitter, where the following continuous signals are transmitted.

In Fig.3, output signal shall be complete receiver side electro-optical characteristics.

Transfer rate	T ₁	T ₂	T ₂ /T ₁	Radiant intensity
9.6kbps	104μs	19.53μs	3/16	40mW/sr
115.2kbps	8.68µs	1.63µs	3/16	40mW/sr
1.152Mbps	868ns	217ns	1/4	100mW/sr
4Mbps (S)	500ns	125ns	1/4	100mW/sr
4Mbps (W)	1 000ns	250ns	1/4	100mW/sr

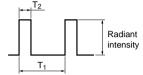


Fig.4 Output Waveform Specification(Transmitter side)

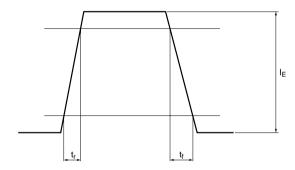


Fig.5 Standard Optical System(Transmitter side)

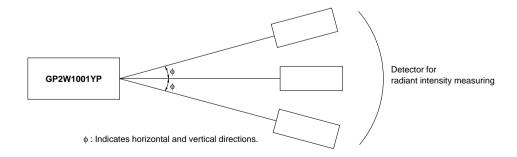


Fig.6 Recommended Circuit of Transmitter side

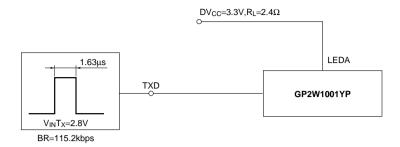


Fig.7 Peak Forward Current vs. Ambient Temperature

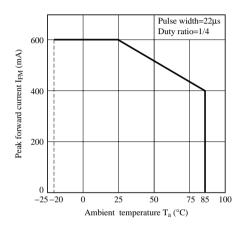


Fig.8 Recommended PCB Foot Pattern

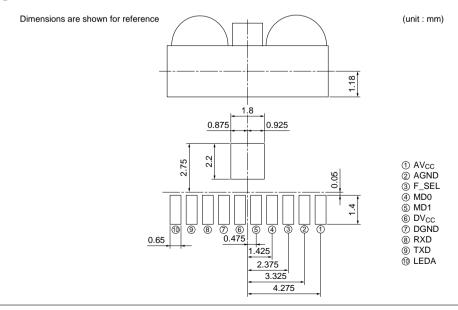
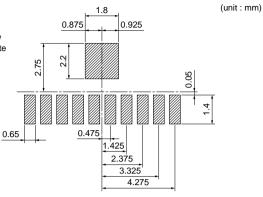


Fig.9 Recommended Size of Solder Creamed Paste (Reference)

Dimensions are shown for reference. Please open the solder mask as below so that the size of solder creamed paste for this device before reflow soldering must be as large as one of the foot pattern land indicated at Fig.8



Solder paste area

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